



PRESS RELEASE

BE Semiconductor Industries N.V. Announces That It Has Taken Note of the Press Release from Applied Materials, Inc. of April 14, 2025

Duiven, the Netherlands, April 15, 2025 - BE Semiconductor Industries N.V. (the "Company" or "Besì") (Euronext Amsterdam: BESI; OTC markets: BESIY), a leading manufacturer of assembly equipment for the semiconductor industry, announced today that it has taken note of the press release from Applied Materials, Inc. ('Applied') in which they announced yesterday that it has purchased nine percent of the outstanding shares of Besì.

According to the press release, Applied views this as a strategic, long-term investment. The investment was made through market-based transactions and is not subject to regulatory approvals. Applied does not intend to seek board representation at Besì, nor does it have plans to purchase additional shares of Besì.

Applied Materials and Besì have co-developed an integrated hybrid bonding system, which has the full capabilities chipmakers need to take the technology to very high-volume manufacturing over the next several years. The system brings together Applied's expertise in front-end wafer and chip processing with high levels of bonding accuracy and speed from Besì's leading die placement, interconnect and assembly solutions.

About Besì

Besì is a leading manufacturer of assembly equipment supplying a broad portfolio of advanced packaging solutions to the semiconductor and electronics industries. We offer customers high levels of accuracy, reliability and throughput at a lower cost of ownership with a principal focus on wafer level and substrate assembly solutions. Customers are primarily leading semiconductor manufacturers, foundries, assembly subcontractors and electronics and industrial companies. Besì's ordinary shares are listed on Euronext Amsterdam (symbol: BESI). Its Level 1 ADRs are listed on the OTC markets (symbol: BESIY) and its headquarters are located in Duiven, the Netherlands. For more information, please visit our website at www.besi.com.

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